

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

## 2SC2879A

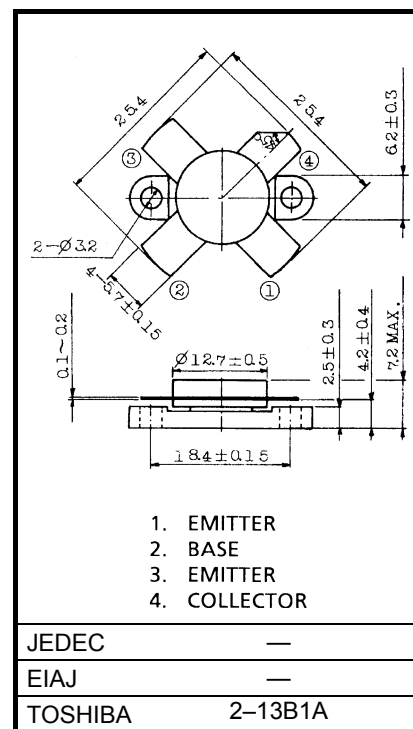
2~30MHz SSB LINEAR POWER AMPLIFIER APPLICATIONS  
(LOW SUPPLY VOLTAGE USE)

Unit in mm

- Specified 12.5V, 28MHz Characteristics
- Output Power :  $P_o = 100W_{PEP}$
- Power Gain :  $G_p = 13dB$
- Collector Efficiency :  $\eta_C = 35\%$  (Min.)
- Intermodulation Distortion:  $IMD = -24dB$  (Max.)  
(MIL Standard)

### ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ C$ )

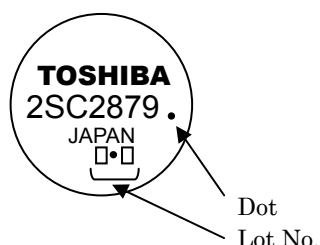
CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CBO}$	45	V
Collector-Emitter Voltage	$V_{CES}$	45	V
Collector-Emitter Voltage	$V_{CEO}$	18	V
Emitter-Base Voltage	$V_{EBO}$	4	V
Collector Current	$I_C$	25	A
Collector Power Dissipation	$P_C$	250	W
Junction Temperature	$T_j$	175	$^\circ C$
Storage Temperature Range	$T_{stg}$	-65~175	$^\circ C$



Weight: 5.2g

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

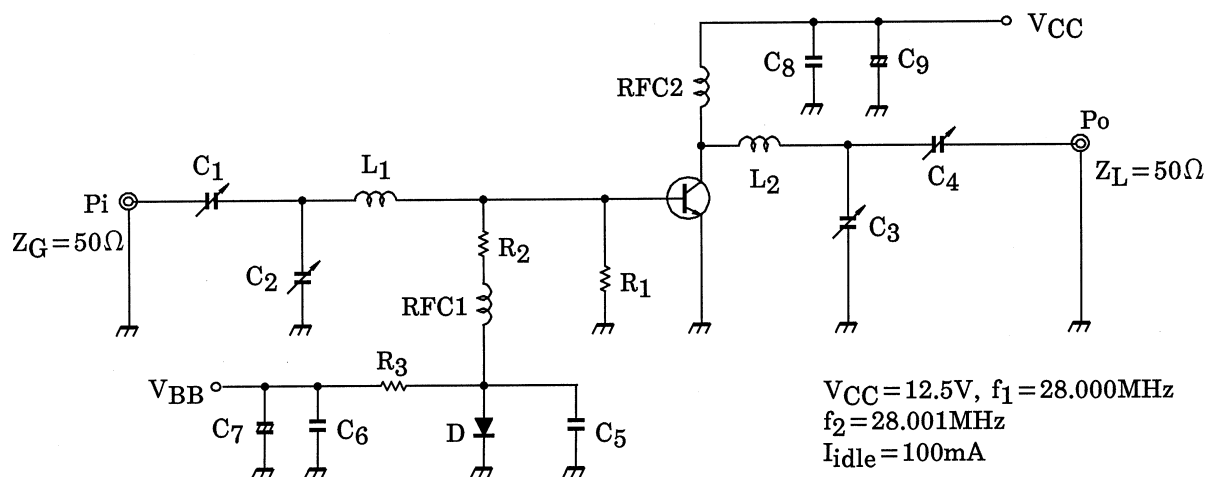
### MARKING



ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector-Emitter Breakdown Voltage	$V_{(BR) CEO}$	$I_C = 100\text{mA}$ , $I_B = 0$	18	—	—	V
Collector-Emitter Breakdown Voltage	$V_{(BR) CES}$	$I_C = 100\text{mA}$ , $V_{EB} = 0$	45	—	—	V
Emitter-Base Breakdown Voltage	$V_{(BR) EBO}$	$I_E = 1\text{mA}$ , $I_C = 0$	4	—	—	V
DC Current Gain	$h_{FE}$	$V_{CE} = 5\text{V}$ , $I_C = 10\text{A}$	10	—	150	
Collector Output Capacitance	$C_{ob}$	$V_{CB} = 12.5\text{V}$ , $I_E = 0$ $f = 1\text{MHz}$	—	700	—	pF
Power Gain	$G_p$	$V_{CC} = 12.5\text{V}$ , $f_1 = 28.000\text{MHz}$ $f_2 = 28.001\text{MHz}$ $I_{idle} = 100\text{mA}$ $P_o = 100W_{PEP}$ (Fig.)	13.0	15.2	—	dB
Input Power	$P_i$		—	6	10	$W_{PEP}$
Collector Efficiency	$\eta_C$		35	—	—	%
Intermodulation Distortion	IMD		—	—	-24	dB
Series Equivalent Input Impedance	$Z_{in}$	$V_{CC} = 12.5\text{V}$ , $f = 28\text{MHz}$ $\Delta f = 1\text{kHz}$ , $P_o = 100W_{PEP}$	—	1.45 -j0.95	—	$\Omega$
Series Equivalent Output Impedance	$Z_{out}$		—	1.45 -j1.0	—	$\Omega$

Fig. Pi TEST CIRCUIT



$C_1, C_2$  : 7~150pF

$C_3, C_4$  : 7~150pF 2KVV

$C_5, C_6$  : 0.022 $\mu$ F

$C_7$  : 47 $\mu$ F 10WV

$C_8$  : 0.044 $\mu$ F

$C_9$  : 100 $\mu$ F 50WV

$L_1$  :  $\phi 0.8$  ENAMEL COATED COPPER WIRE, 14ID, 4T, 4P

$L_2$  :  $\phi 1.2$  ENAMEL COATED COPPER WIRE, 14ID, 3 1/2T, 3P

$RFC1$  :  $\phi 0.8mm$  ENAMEL COATED COPPER WIRE, 10ID, 9T  
(Ferrite Core TDK K2)

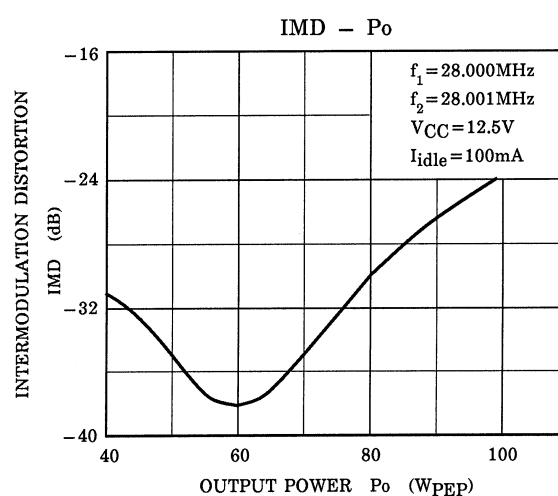
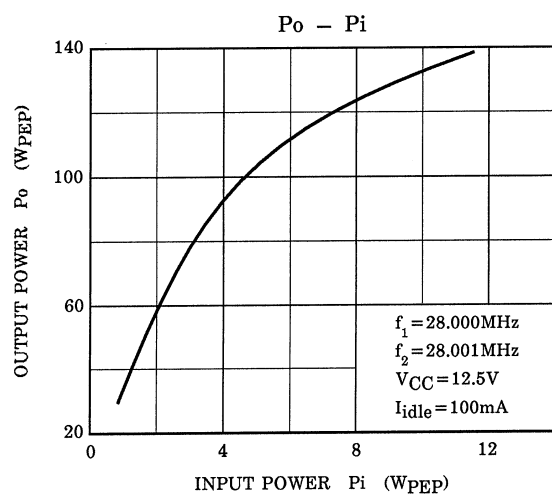
$RFC2$  :  $\phi 1.8mm$  ENAMEL COATED COPPER WIRE, 14ID, 20T

$R_1$  : 10 $\Omega$  (1W)

$R_2$  : 2 $\Omega$  (1/2W)

$R_3$  : 10 $\Omega$  (5W)

$D$  : 1S1555



## CAUTION

These are only typical curves and devices are not necessarily guaranteed at these curves.

**RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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